



Product Change Notification

112131 - 00

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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Product Change Notification

Change Notification #: 112131 - 00
Change Title: Intel® SSD 520 Series (60GB, 180GB, 240GB, 480GB)
PCN 112131-00, Manufacturing Site, Label
Addition of Manufacturing Site
Date of Publication: March 14, 2013

Key Characteristics of the Change:

Manufacturing Site
Label

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material:	Apr 13, 2013
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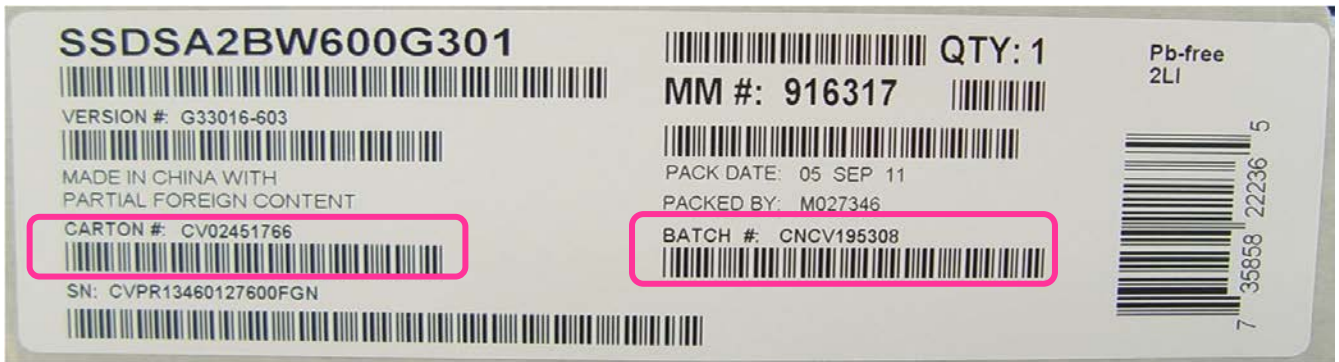
Description of Change to the Customer:

Intel is adding an additional manufacturing site to manufacture the Intel® SSD 520 Series Solid-State Drives. The new manufacturing site will be using the identical manufacturing process as the existing manufacturing sites to produce Intel® SSD 520 Series Solid-State Drives. There will be some aesthetic changes to the labels. Generic examples are below:

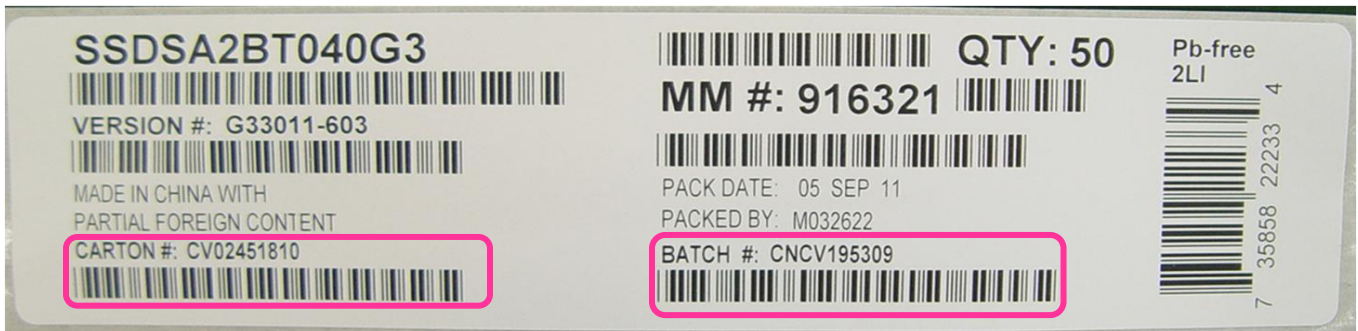
Label on the SSD: Serial Number (ISN) will begin with EK



Label on Pizza Box: Carton # will begin with EK and Batch # will begin with CNEK



Label on Exterior Box: Carton # will begin with EK and Batch # will begin with CNEK



Customer Impact of Change and Recommended Action:

Intel anticipates no impact to customers.

Products Affected / Intel Ordering Codes:

Product Code	MM#
SSDSC2CW240A3K5	915880
SSDSC2CW480A3K5	915881
SSDSC2CW240A310	917126
SSDSC2CW480A310	917127
SSDSC2CW060A3K5	917130
SSDSC2CW060A310	917132
SSDSC2CW060A301	917695
SSDSC2CW240A301	917698
SSDSC2CW480A301	917699
SSDSC2CW180A301	918393
SSDSC2CW180A310	918395
SSDSC2CW180A3K5	918397
SSDSC2BW060A3FE	923191
SSDSC2BW180A3FE	923193
SSDSC2BW240A3FE	923194
SSDSC2BW480A3FE	923195
SSDSC2BW180A3	923205
SSDSC2BW240A301	923206
SSDSC2BW240A3	923207
SSDSC2BW180A301	923333

PCN Revision History:

Date of Revision:

March 14, 2013

Revision Number:

00

Reason:

Originally Published PCN